# **GP2L09/GP2L24 GP2L26**

#### **■** Features

1. Compact and thin

GP2L09: Compact DIP, long lead type

**GP2L24**: Compact DIP type **GP2L26**: Flat lead type

2. Optimum detection distance: 0.6 to 0.8mm

3. High sensitivity

( $I_C$ : MIN. 0.5mA at  $I_F$ = 4mA)

4. Visible light cut-off type

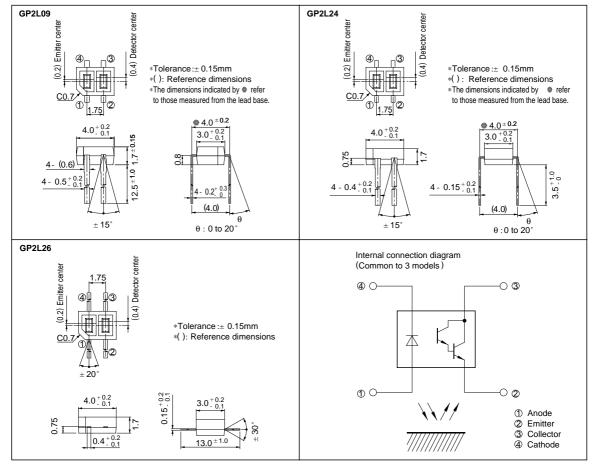
# Subminiature, High Sensitivity Photointerrupter

### ■ Applications

- 1. Cassette tape recorders, VCRs
- 2. Floppy disk drives
- 3. Various microcomputerized control equipment

# **■** Outline Dimensions

(Unit: mm)



# **■** Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$ 

	Parameter	Symbol	Rating	Unit	
Input	Forward current	$I_F$	50	mA	
	Reverse voltage	V <sub>R</sub>	6	V	
	Power dissipation	P	75	mW	
	Collector-emitter voltage	V <sub>CEO</sub>	35	V	
0	Emitter-collector voltage	V <sub>ECO</sub>	6	V	
Output	Collector current	Ic	50	mA	
	Collector power dissipation	Pc	75	mW	
,	Total power dissipation	P <sub>tot</sub>	100	mW	
	Operating temperature	Topr	T <sub>opr</sub> - 25 to + 85		
	Storage temperature	T stg	- 40 to + 100	°C	
	*1Soldering temperature	T sol	260	°C	

<sup>\*1</sup> Within 5 seconds (Soldering areas for each model are shown below.)

#### GP2L09, GP2L24

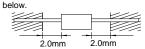
Soldering area

The hatched area more than 1mm\*2 away from the lower edge of package as shown in the drawing below.



#### GP2L26

Soldering area The hatched area more than 2.0mm away from the both edge of package as shown in the drawing



# **■** Electro-optical Characteristics

 $(Ta = 25^{\circ}C)$ 

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Innut	Forward voltage		$I_F$	$I_F = 20 mA$	-	1.2	1.4	V
Input	Reverse current		$I_R$	$V_R = 6V$	-	-	10	μΑ
Output	Collector dark current		I <sub>CEO</sub>	$V_{CE} = 10V, I_{F} = 0$	-	-	1x 10 - 6	A
	*3Collector current		Ic	$V_{CE} = 2V$ , $I_F = 4mA$	0.5	3.0	15.0	mA
Transfer- charac- teristics	Response time	Rise time	$t_{\rm r}$	$V_{CE} = 2V, I_{C} = 10mA$	-	80	400	μs
		Fall time	$t_{\mathrm{f}}$	$R_L=100\Omega$ , $d=1mm$	-	70	400	μs
	*4Leak current		ILEAK	$I_F=4mA,V_{CE}=5V$	-	-	5.0	μΑ

<sup>\*3</sup> The condition and arrangement of the reflective object are shown in the right drawing.

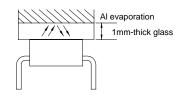
The ranking of collector current shall be classified into the following 6 ranks.

#### (GP2L09, GP2L24, GP2L26)

Rank	Collector current I <sub>C</sub> (mA)			
*5A	0.5 to 1.9			
В	1.45 to 5.4			
С	4.0 to 15.0			
A or B	0.5 to 5.4			
B or C	1.45 to 15.0			
A, B or C	0.5 to 15.0			

<sup>\*5</sup> **GP2L24** and **GP2L26** don't have A rank.

#### **Test Condition for Collector Current**



<sup>\*4</sup> Without reflective object

Fig. 1 Forward Current vs.

Ambient Temperature

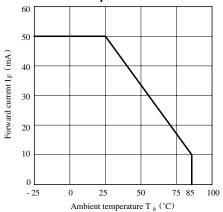


Fig. 3 Peak Forward Current vs. Duty Ratio

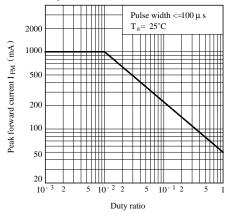


Fig. 5 Collector Current vs. Forward Current

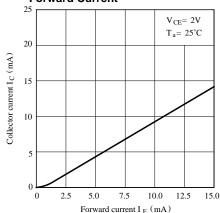


Fig. 2 Power Dissipation vs.
Ambient Temperature

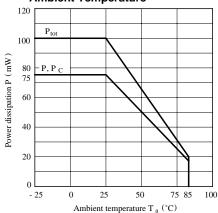


Fig. 4 Forward Current vs. Forward Voltage

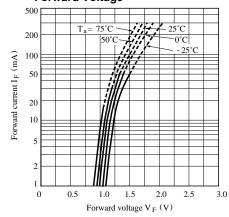


Fig. 6 Collector Current vs.
Collector-emitter Voltage

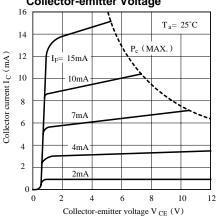


Fig. 7 Relative Collector Current vs.
Ambient Temperature

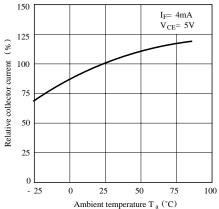
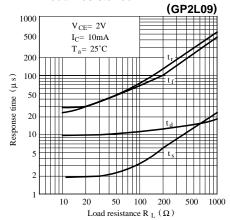


Fig. 9-a Response Time vs. Load Resistance



**Test Circuit for Response Time** 

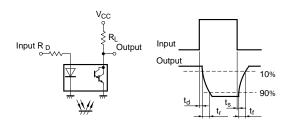


Fig. 8 Collector Dark Current vs.
Ambient Temperature

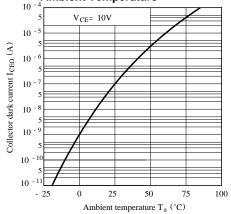


Fig. 9-b Response Time vs. Load Resistance

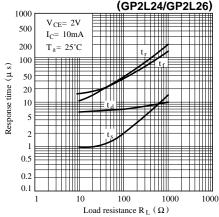
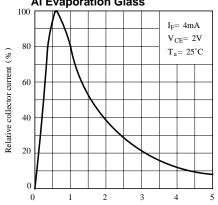
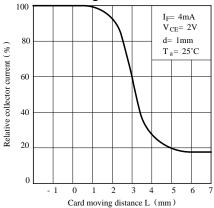


Fig.10 Relative Collector Current vs.
Distance between Sensor and
Al Evaporation Glass



Distance between sensor and Al evaporation glass d (mm)

Fig.11 Relative Collector Current vs. Card Moving Distance (1)



Test Condition for Distance & Detecting Position Characteristics

Fig.12 Relative Collector Current vs. Card Moving Distance (2)

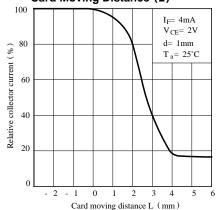


Fig.13 Frequency Response (GP2L09)

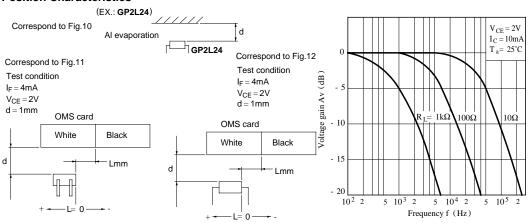


Fig.14 Frequency Response (GP2L24/GP2L26)

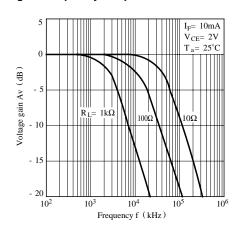
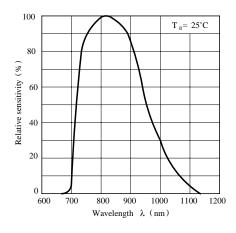


Fig.15 Spectral Sensitivity (Detecting Side)



#### ■ Precautions for Use

- (1) In order to stabilize power supply line, connect a by-pass capacitor of more than  $0.01\,\mu\,F$  between Vcc and GND near the device.
- (2) In this product, the PWB is fixed with a resin cover, and cleaning solvent may remain inside the case; therefore, dip cleaning or ultrasonic cleaning are prohibited.
- (3) Remove dust or stains, using an air blower or a soft cloth moistened in cleaning solvent. However, do not perform the above cleaning using a soft cloth with cleaning solvent in the marking portion.
  - In this case, use only the following type of cleaning solvent used for wiping off: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol, Freon TE, Freon TF, Diflon solvent S3-E When the cleaning solvents except for specified materials are used, please consult us.
- (4) As for other general cautions, refer to the chapter "Precautions for Use".

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